

SGM05HB1AM 5V Bidirectional ESD and Surge Protection Device

GENERAL DESCRIPTION

The SGM05HB1AM is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, high peak pulse current handling capability and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, tablets, digital cameras and many other portable applications where board space comes at a premium.

FEATURES

- Low Clamping Voltage
- Low Leakage
- Small Package: UTDFN-1×0.6-2AL
- Protection for the Following IEC Standards:
 IEC 61000-4-2 Level 4: ±30kV Contact Discharge
 IEC 61000-4-5 (Lightning) 30A (8/20µs)
- These Devices are Pb-Free, Halogen Free/BFR
 Free and are RoHS Compliant

APPLICATIONS

Battery Line Protection Audio Line Protection GPIO

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Current (tp = 8/20µs)	I _{PP}	30	Α
ESD IEC 61000-4-2 (Air)		±30	kV
ESD IEC 61000-4-2 (Contact)	V _{ESD}	±30	KV
Operating Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C
Lead Temperature (Soldering, 10s)		+260	°C

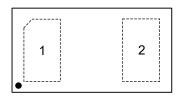
Stresses exceeding those listed in Maximum Ratings may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

PRODUCT SUMMARY

V _{RWM} (TYP)	IPP (TYP)	C _{IN} (TYP)
4.8V/5.5V	30A	36pF

PIN CONFIGURATION

(TOP VIEW)



UTDFN-1×0.6-2AL

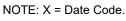
EQUIVALENT CIRCUIT

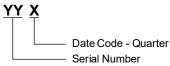


PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE SPECIFIED TEMPERATURE RANGE		TEMPERATURE ORDERING NUMBER		PACKING OPTION
SGM05HB1AM	UTDFN-1×0.6-2AL	-40°C to +125°C	SGM05HB1AMXUEZ2G/TR	01X	Tape and Reel, 10000

MARKING INFORMATION





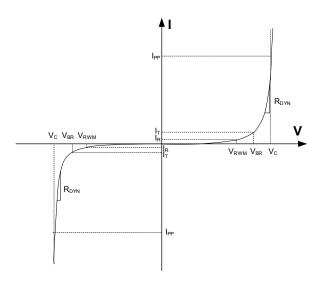
Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

ELECTRICAL PARAMETERS

SYMBOL	PARAMETER				
I _{PP}	Maximum Reverse Peak Pulse Current				
V _C	Clamping Voltage @ I _{PP}				
V_{RWM}	Working Peak Reverse Voltage				
I _R Maximum Reverse Leakage Current @ V _{RV}					
V_{BR}	Breakdown Voltage @ I _⊤				
I _T	Test Current				



ELECTRICAL CHARACTERISTICS

(T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Boyeres Warking Voltage	V	I/O pin to GND	pin 1 to pin 2			4.8	V
Reverse Working Voltage	V_{RWM}	I/O pin to GND	pin 2 to pin 1			5.5]
Dun alidania Valtana		- 4 - A 1/O - in to CND	pin 1 to pin 2	5.2	5.7	7.8	V
Breakdown Voltage	V_{BR}	I _T = 1mA, I/O pin to GND	pin 2 to pin 1	6.0	6.9	7.8]
Dayoraa Laakaga Current	1	V _{RWM} = 5V, pin 1 to pin 2				0.5	
Reverse Leakage Current	I _R	V _{RWM} = 5V, pin 2 to pin 1				0.5	μA
Clamping Voltage TLD (1)	V	I _{PP} = 8A, IEC 61000-4-2 le (±4kV contact, ±8kV air)	evel 2 equivalent		5.8 6.7		V
Clamping Voltage TLP (1)	V _C	I _{PP} = 16A, IEC 61000-4-2 (±8kV contact, ±15kV air)	level 4 equivalent		6.0 7.0]
Reverse Peak Pulse Current	I _{PP}	IEC 61000-4-5 (8 × 20µs) per		30			Α
Clamping Voltage 8 × 20µs Waveform	.,,	I _{PP} = 1A			6.2	8	.,
per ⁽²⁾	Vc	I _{PP} = 30A			9.6	11	V
Dynamic Resistance	R_{DYN}	100ns TLP pulse			0.03		Ω
Junction Capacitance	CJ	V _R = 0V, f = 1MHz			36	80	pF

NOTES:

- 1. Non-repetitive current pulse, Transmission Line Pulse (TLP) t_P = 100ns, square pulse.
- 2. Non-repetitive current pulse 8/20μs exponential decay waveform according to IEC 61000-4-5, 2Ω source impedance.

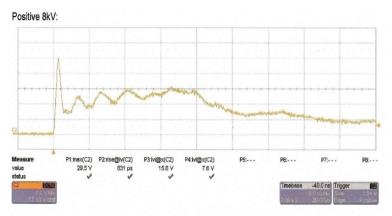


Figure 1. Typical Pulses ESD 8kV Contact per IEC 61000-4-2

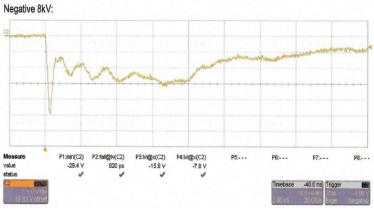
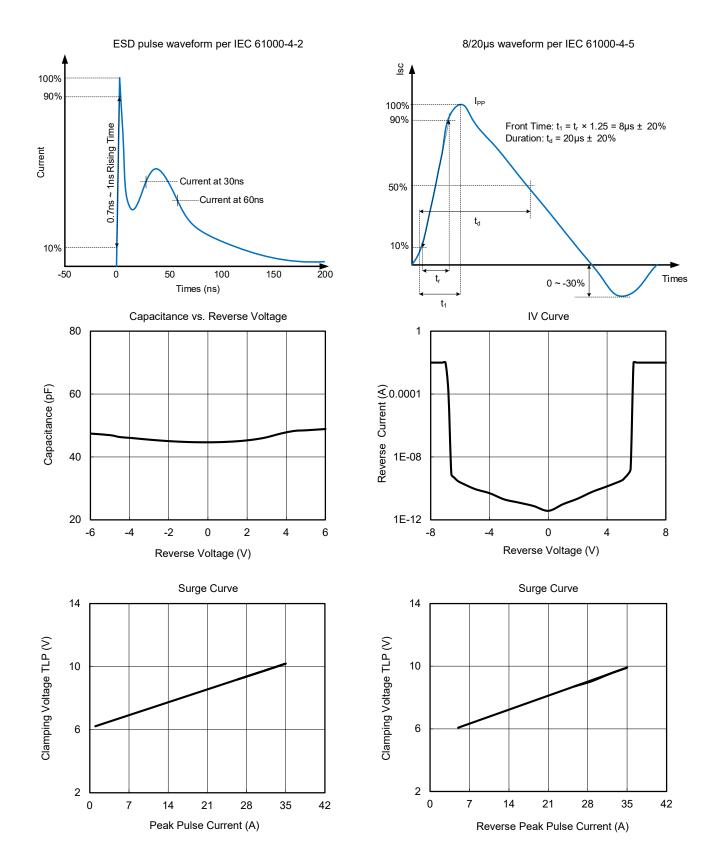
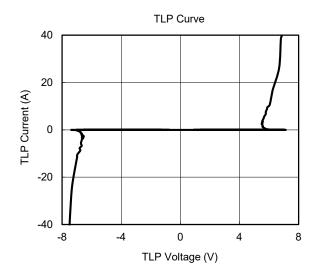


Figure 2. Typical Pulses ESD -8kV Contact per IEC 61000-4-2

TYPICAL PERFORMANCE CHARACTERISTICS

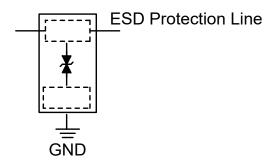


TYPICAL PERFORMANCE CHARACTERISTICS (continued)



APPLICATION INFORMATION

The TVS is designed to provide a bidirectional line for dissipating ESD events on high-speed signal. The TVS is suitable for lines with positive and negative signal polarity relative to the ground.



The following guidelines are recommended:

1. TVS Placement

Place the TVS as close to the input connector as possible.

2. TVS's Trace Layout

Avoid running protected traces in parallel with unprotected traces.

Minimize the path length between the TVS and the protected line.

Minimize parallel signal path length.

Route the protected traces as straight as possible.

3. GND Layout

Avoid using a common ground point shared with the TVS transient return path.

Minimize the length of the TVS transient return path to ground.

Use ground vias as close as possible to the TVS transient return to ground.

REVISION HISTORY

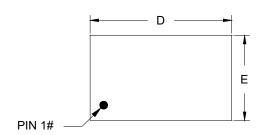
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

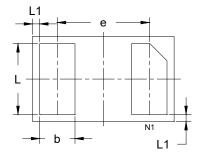
Changes from Original (NOVEMBER 2023) to REV.A

Page



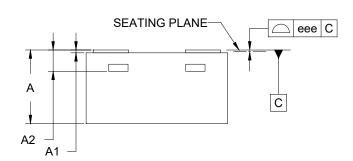
PACKAGE OUTLINE DIMENSIONS UTDFN-1×0.6-2AL

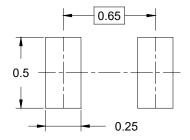




TOP VIEW

BOTTOM VIEW





SIDE VIEW

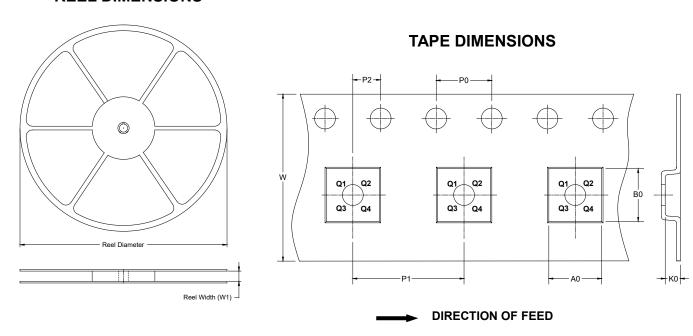
RECOMMENDED LAND PATTERN (Unit: mm)

Cumb of	Dir	nensions In Millimet	ers				
Symbol	MIN	MOD	MAX				
Α	0.450	-	0.550				
A1	0.000	-	0.050				
A2		0.150 REF					
b	0.200	-	0.300				
D	0.950	-	1.050				
E	0.550 -		0.650				
е	0.650 BSC						
L	0.450	0.550					
L1	0.050 REF						
eee	0.050						

NOTE: This drawing is subject to change without notice.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

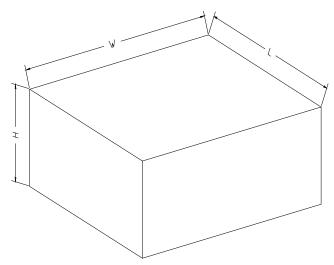


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
UTDFN-1×0.6-2AL	7"	8.6	0.70	1.15	0.57	4.0	2.0	2.0	8.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18